

# WHITE LED CHARGE PUMP CURRENT SOURCE WITH PWM BRIGHTNESS CONTROL

Check for Samples: [TPS60231](#)

## FEATURES

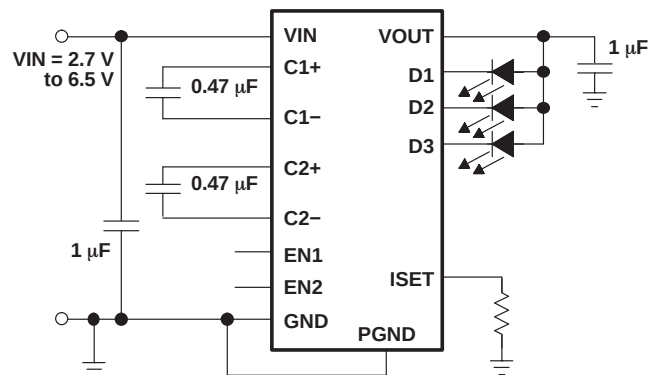
- Regulated Output Current With 0.4% Matching
- Drives up to 3 LEDs at 25 mA Each
- LED Brightness Control Through PWM Control Signal
- High Efficiency by Fractional Conversion With 1x and 1.5x Modes
- 1 MHz Switching Frequency
- 2.7 V to 6.5 V Operating Input Voltage Range
- Internal Softstart Limits Inrush Current
- Low Input Ripple and Low EMI
- Overcurrent and Overtemperature Protected
- Undervoltage Lockout With Hysteresis
- Ultra-Small 3mm x 3mm QFN Package

## APPLICATIONS

- White LED Backlight for Color Displays in Cellular Phones, Smart Phones, PDAs, Handheld PCs, Digital Cameras, and Camcorders
- Keypad Backlight

## DESCRIPTION

The TPS60231 charge pump is optimized for white LED supplies in color display backlight applications. The device provides a constant current for each LED, which the initial value can be set by an external resistor. The supply voltage ranges from 2.7 V to 6.5 V and is ideally suited for all applications powered by a single LI-Ion battery cell or three to four NiCd, NiMH, or alkaline battery cells. Over an input voltage range from 3.1 V to 6.5 V, the device provides a high output current of up to 25 mA per LED with a total of 75 mA. High efficiency is achieved by utilizing a 1x/1.5x fractional conversion technique in combination with very low dropout current sources. In addition, the current controlled charge pump ensures low input current ripple and EMI. Only two external 1  $\mu$ F and two 0.47  $\mu$ F capacitors are required to build a complete small and low cost power supply solution. To reduce board space to a minimum, the device switches at 1 MHz operating frequency and is available in a small 16-pin QFN (RGT) package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### ORDERING INFORMATION

| PACKAGED DEVICE <sup>(1)</sup> <sup>(2)</sup> | PACKAGE | MARKING |
|-----------------------------------------------|---------|---------|
| TPS60231RGTR                                  | QFN     | BKH     |

(1) T indicates shipment in tape and reel on a mini reel with 250 units per reel.

(2) R indicates shipment in tape and reel with 3000 units per reel.

### ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                               | UNIT                     |
|-----------------------------------------------|--------------------------|
| V <sub>I</sub> Supply voltage                 | –0.3 V to 7 V            |
| Voltage at EN1, EN2, VOUT, ISET               | –0.3 V to V <sub>I</sub> |
| Output current at VOUT                        | 150 mA                   |
| T <sub>J</sub> Maximum junction temperature   | 150°C                    |
| T <sub>A</sub> Operating free-air temperature | –40°C to 85°C            |
| T <sub>st</sub> Storage temperature           | –65°C to 150°C           |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### DISSIPATION RATINGS<sup>(1)</sup>

| PACKAGE          | T <sub>A</sub> ≤ 25°C<br>POWER RATING | DERATING FACTOR<br>ABOVE T <sub>A</sub> = 25°C | T <sub>A</sub> = 70°C<br>POWER RATING | T <sub>A</sub> = 85°C<br>POWER RATING |
|------------------|---------------------------------------|------------------------------------------------|---------------------------------------|---------------------------------------|
| 16-Pin QFN (RGT) | 1.9 W                                 | 20 mW/°C                                       | 1 W                                   | 760 mW                                |

(1) The thermal resistance junction to ambient of the QFN package is 52°C/W.

### RECOMMENDED OPERATING CONDITIONS

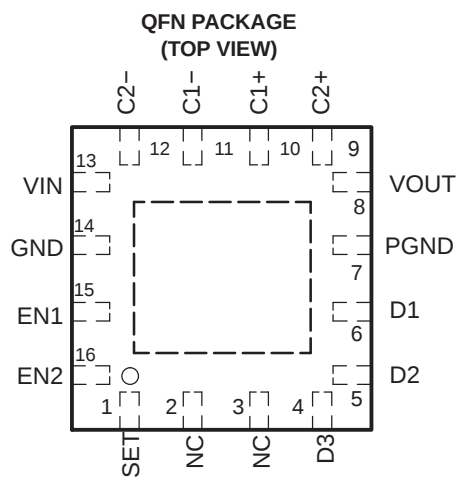
|                                 | MIN  | TYP  | MAX | UNIT |
|---------------------------------|------|------|-----|------|
| Supply voltage at VIN           | 2.7  |      | 6.5 | V    |
| Maximum output current at VOUT  | 75   |      |     | mA   |
| C <sub>I</sub> Input capacitor  | 1    |      |     | μF   |
| C <sub>O</sub> Output capacitor | 0.47 | 1    |     | μF   |
| Flying capacitor, C1, C2        | 0.22 | 0.47 |     | μF   |
| Operating junction temperature  | –40  |      | 125 | °C   |

## ELECTRICAL CHARACTERISTICS

 $V_I = 3.6\text{ V}$ ,  $EN1 = EN2 = V_I$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$  (unless otherwise noted)

| PARAMETER                  |                                                            | TEST CONDITIONS                                                                      | MIN  | TYP  | MAX  | UNIT |
|----------------------------|------------------------------------------------------------|--------------------------------------------------------------------------------------|------|------|------|------|
| SUPPLY VOLTAGE AND CURRENT |                                                            |                                                                                      |      |      |      |      |
| V <sub>I</sub>             | Input voltage range                                        | I <sub>O</sub> = 0 mA to 75 mA                                                       | 2.7  |      | 6.5  | V    |
|                            |                                                            | I <sub>O</sub> = 0 mA to 45 mA, V <sub>LED</sub> ≤ 2.1 V, T = 0°C to 85°C            | 2.5  |      | 6.5  | V    |
| I <sub>Q</sub>             | Operating quiescent current                                | V <sub>I</sub> = 4.2 V, x1-mode, EN1 = EN2 = 1, ISET = 20 μA                         |      | 200  |      | μA   |
|                            |                                                            | I <sub>O</sub> = 0 mA, x1.5-mode                                                     |      | 2.1  |      | mA   |
| I <sub>SD</sub>            | Shutdown current                                           | EN2 = EN1 = GND                                                                      |      | 0.1  | 1    | μA   |
| CHARGE PUMP STAGE          |                                                            |                                                                                      |      |      |      |      |
| V <sub>OUT</sub>           | Overvoltage limit                                          | LED1 unconnected, V <sub>I</sub> = 4.2 V                                             |      | 5.5  |      | V    |
|                            | Startup time                                               | C <sub>O</sub> = 1 μF, I <sub>DX</sub> ≥ 0.9 I <sub>DX</sub> , set                   |      | 375  |      | μs   |
|                            | Softstart duration                                         |                                                                                      |      | 160  |      | μs   |
| f                          | Switching frequency                                        |                                                                                      | 0.75 | 1    | 1.25 | MHz  |
| η                          | Efficiency                                                 | V <sub>I</sub> = 3.7 V, I <sub>LED</sub> = 15 mA each, V <sub>DX</sub> = 3.1 V       |      | 83%  |      |      |
|                            | Shutdown temperature                                       | Temperature rising                                                                   |      | 160  |      | °C   |
|                            | Shutdown temperature hysteresis                            |                                                                                      |      | 20   |      | °C   |
|                            | Input current limit                                        | EN2 = EN1 = 1, ISET = 100 μA                                                         |      | 350  |      | mA   |
| CURRENT SINKS              |                                                            |                                                                                      |      |      |      |      |
| I <sub>DX</sub>            | Recommended maximum current per current sink               | 3.2 V ≤ V <sub>I</sub> ≤ 6.5 V                                                       |      | 25   |      | mA   |
| I <sub>DX</sub>            | Current into each current sink when ISET is shorted to GND | 3.0 V ≤ V <sub>I</sub> ≤ 6.5 V, ISET shorted to GND                                  |      | 50   |      | mA   |
|                            | Current matching between any two outputs                   | V <sub>DX</sub> = 3.1 V, T <sub>A</sub> = 25°C                                       | −2%  | 0.4% | 2%   |      |
|                            | Line regulation                                            | 3.2 V ≤ V <sub>I</sub> ≤ 6.5 V, V <sub>DX</sub> = 3.1 V, EN1 = EN2 = 1, ISET = 80 μA |      |      | ±3%  |      |
| V <sub>ISET</sub>          | Reference voltage for current set                          | EN2 = 0, EN1 = 1                                                                     |      | 200  |      | mV   |
|                            |                                                            | EN2 = 1, EN1 = 0                                                                     |      | 400  |      |      |
|                            |                                                            | EN2 = 1, EN1 = 1                                                                     | 580  | 600  | 620  |      |
| Iset                       | Recommended ISET pin current range                         |                                                                                      | 4    |      | 130  | μA   |
| K                          | I <sub>DX</sub> to ISET current ratio                      | EN2 = EN1 = 1, ISET = 80 μA                                                          | 230  | 260  | 280  |      |
| V <sub>source</sub>        | Voltage at Dx to GND                                       | EN2 = 0, EN1 = 1                                                                     |      | 200  |      | mV   |
|                            |                                                            | EN2 = 1, EN1 = 0                                                                     |      | 300  |      |      |
|                            |                                                            | EN2 = 1, EN1 = 1                                                                     |      | 400  |      |      |
| ENABLE 1, ENABLE 2         |                                                            |                                                                                      |      |      |      |      |
| V <sub>IH</sub>            | EN1, EN2 high level input voltage                          |                                                                                      | 1.3  |      |      | V    |
| V <sub>IL</sub>            | EN1, EN2 low level input voltage                           |                                                                                      |      | 0.3  |      | V    |
|                            | EN1, EN2 trip point hysteresis                             |                                                                                      |      | 50   |      | mV   |
| I <sub>IKG</sub>           | EN2 input leakage current                                  | EN1, EN2 = GND or EN2 = V <sub>I</sub> , V <sub>I</sub> = 6.5 V                      |      | 0.01 | 1    | μA   |
| I <sub>IKG</sub>           | EN1 input leakage current                                  | EN1 = V <sub>I</sub> , V <sub>I</sub> = 4.2 V                                        |      | 11   | 15   | μA   |
| UVLO                       | Undervoltage lockout threshold                             | Input voltage falling                                                                |      | 2.1  |      | V    |
|                            | Undervoltage lockout hysteresis                            |                                                                                      |      | 50   |      | mV   |
|                            | Frequency range at PWM                                     |                                                                                      | 0    |      | 50   | kHz  |
|                            | Recommended ON-time for PWM signal                         |                                                                                      |      | 2.5  |      | μs   |
|                            | Shutdown delay time                                        | Delay time when EN1 = EN2 go to GND after which the TPS60231 shuts down completely   | 0.5  | 0.85 | 1.5  | ms   |

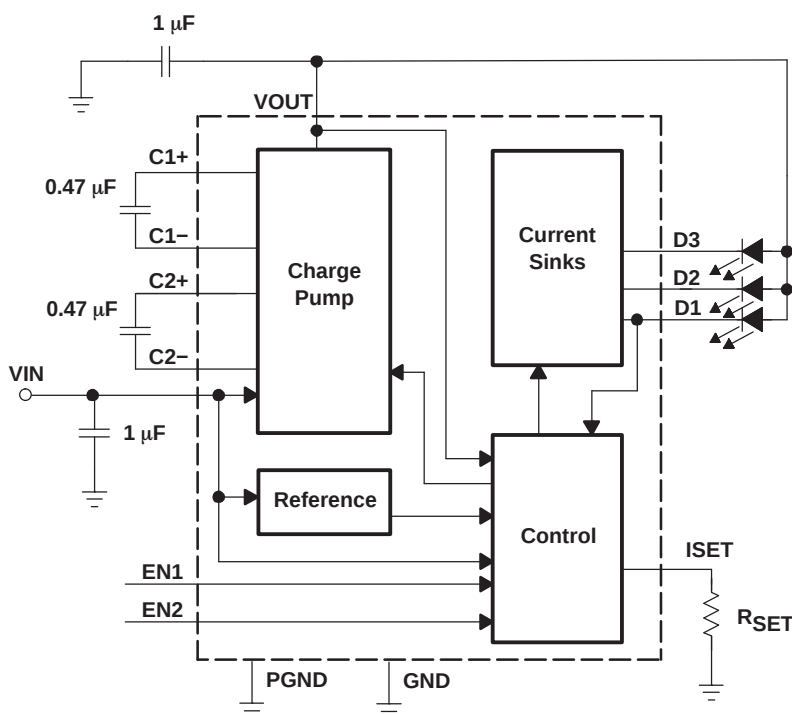
## PIN ASSIGNMENT



## Pin Functions

| PIN<br>NAME | NO.  | I/O | DESCRIPTION                                                                                                                                                                                                                                                                                                                                               |
|-------------|------|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1+         | 10   | –   | Connect to the flying capacitor C1                                                                                                                                                                                                                                                                                                                        |
| C1–         | 11   | –   | Connect to the flying capacitor C1                                                                                                                                                                                                                                                                                                                        |
| C2+         | 9    | –   | Connect to the flying capacitor C2                                                                                                                                                                                                                                                                                                                        |
| C2–         | 12   | –   | Connect to the flying capacitor C2                                                                                                                                                                                                                                                                                                                        |
| D1-D3       | 6-4  | I   | Current sink input. Connect the cathode of the white LEDs to these inputs.                                                                                                                                                                                                                                                                                |
| EN1         | 15   | I   | Enable input. A logic high enables the converter, logic low forces the device into shutdown mode reducing the supply current to less than 1 $\mu$ A if EN2 is tied to GND.                                                                                                                                                                                |
| EN2         | 16   | I   | An applied PWM signal reduces the LED current as a function of the duty cycle of the PWM signal. EN1 and EN2 can be tied together for PWM dimming between 0 mA and the maximum set with ISET. EN1 and EN2 can also be used for digital dimming with 4 steps from 0 mA to the maximum current set with ISET. See the application section for more details. |
| GND         | 14   | –   | Analog ground                                                                                                                                                                                                                                                                                                                                             |
| ISET        | 1    | I   | Connect a resistor between this pin and GND to set the maximum current through the LEDs.                                                                                                                                                                                                                                                                  |
| NC          | 2, 3 | –   | No internal connection                                                                                                                                                                                                                                                                                                                                    |
| PGND        | 7    | –   | Power ground                                                                                                                                                                                                                                                                                                                                              |
| VIN         | 13   | I   | Supply voltage input                                                                                                                                                                                                                                                                                                                                      |
| VOUT        | 8    | O   | Connect the output capacitor and the anode of the LEDs to this pin.                                                                                                                                                                                                                                                                                       |
| Power PAD   | –    | –   | Connect with PGND and GND                                                                                                                                                                                                                                                                                                                                 |

## FUNCTIONAL BLOCK DIAGRAM



## TYPICAL CHARACTERISTICS

### Table of Graphs

|                                               |                                                                                                                                                                      | FIGURE |
|-----------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| $\eta$ Efficiency                             | vs Input voltage ( $I_{LED} = 25\text{ mA}, 15\text{ mA}, 10\text{ mA}, 5\text{ mA per LED}$ ),<br>EN2 = 0, EN1 = 1                                                  | 1      |
|                                               | vs Input voltage ( $I_{LED} = 25\text{ mA}, 15\text{ mA}, 10\text{ mA}, 5\text{ mA per LED}$ ),<br>EN2 = 1, EN1 = 0                                                  | 2      |
|                                               | vs Input voltage ( $I_{LED} = 25\text{ mA}, 15\text{ mA}, 10\text{ mA}, 5\text{ mA per LED}$ ),<br>EN2 = EN1 = 1                                                     | 3      |
| $I_Q$ Quiescent current                       | vs Input voltage ( $T_A = -40^\circ\text{C}, 25^\circ\text{C}, 85^\circ\text{C}$ ) (measured with $I_{D1} = 5\text{ mA}$ )                                           | 4      |
| Maximum output current from charge pump stage | vs Input voltage ( $T_A = -40^\circ\text{C}, 25^\circ\text{C}, 85^\circ\text{C}$ )                                                                                   | 5      |
| $f_s$ Switching frequency                     | vs Free-Air Temperature ( $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$ , $V_I = 3.6\text{ V}$ )                                                                   | 6      |
| LED current, $I_{LED}$                        | vs Duty cycle on PWM ( $I_{LED}$ max set to $20\text{ mA}$ )<br>For $f = 32\text{ kHz}$ and $f = 1\text{ kHz}$ , DC = 1% to 100%, $V_I = 3.6\text{ V}$               | 7      |
| Line transient response                       | $V_I$ and $I_{D1}$ vs time on scope, LED current at D1 with<br>$V_I = 4.2\text{ V}$ to $3.6\text{ V}$ to $4.2\text{ V}$ with EN2 = EN1 = 11, $3 \times 20\text{ mA}$ | 8      |
| Dimming response                              | PWM signal and current at D1 vs time on scope<br>$f = 32\text{ kHz}$ and $f = 1\text{ kHz}$ , $V_I = 3.6\text{ V}$ , duty cycle = 50%,<br>EN1 = EN2 = PWM            | 9, 10  |
| Startup timing                                | $V_I = 3.6\text{ V}$ , $3 \times 20\text{ mA}$ , EN1 = EN2 = 00 changed to<br>EN2 = EN1 = 11                                                                         | 11     |

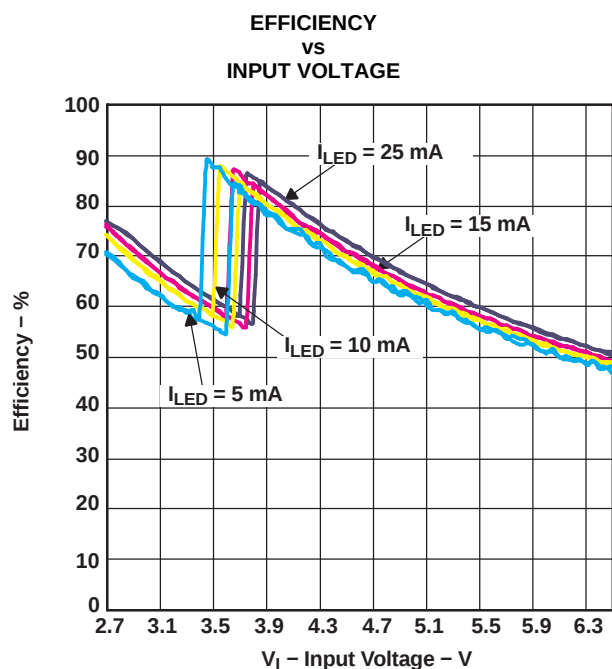


Figure 1.

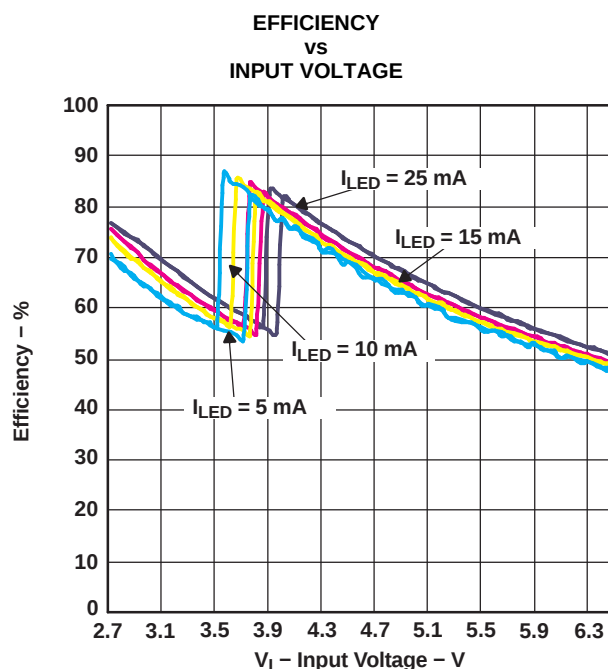


Figure 2.

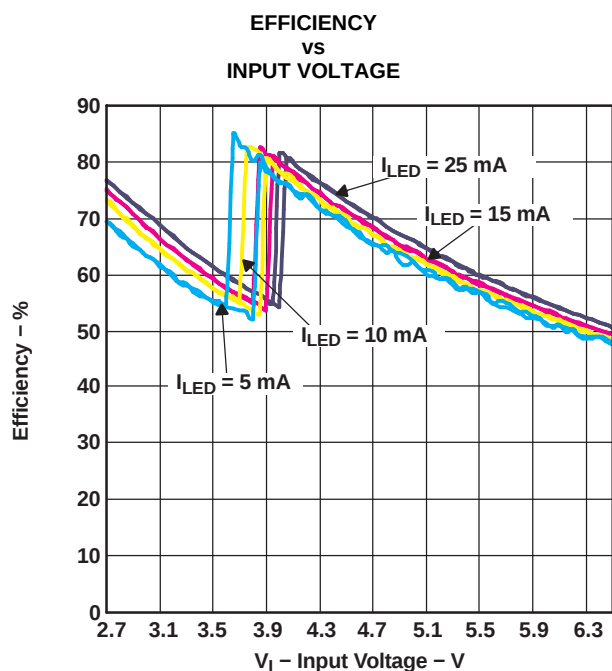


Figure 3.

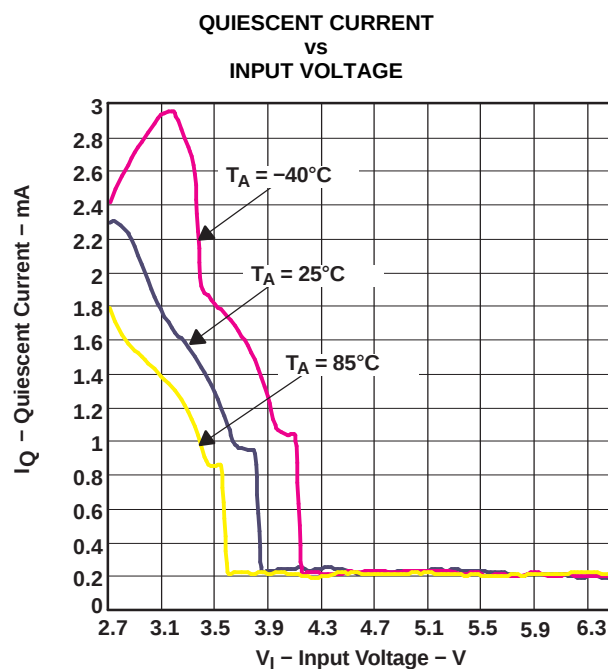


Figure 4.

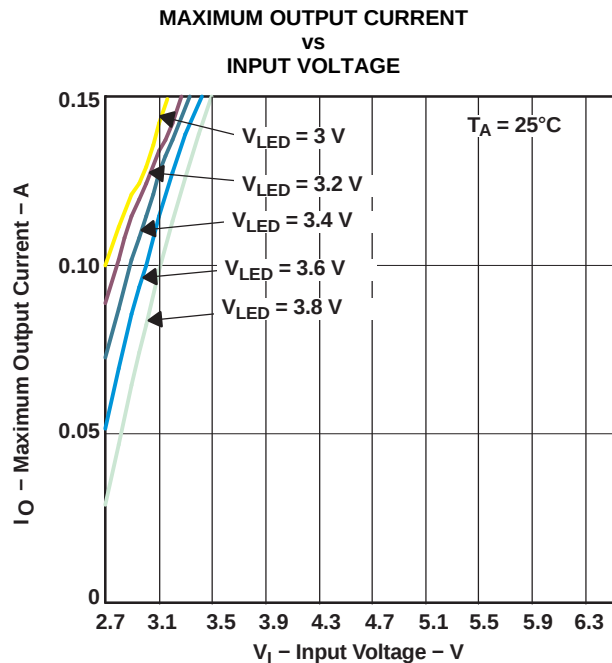


Figure 5.

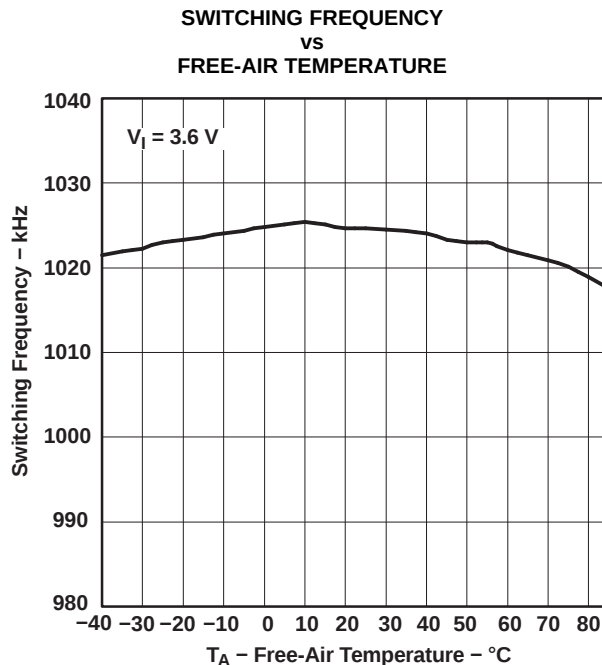


Figure 6.

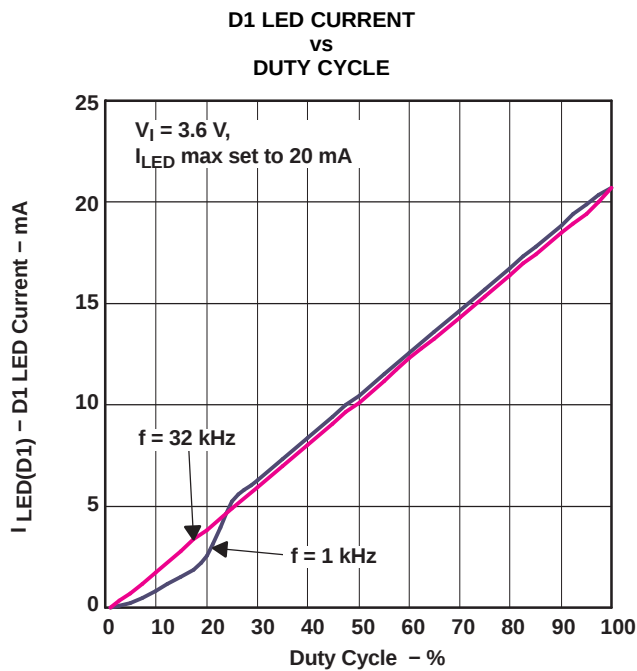


Figure 7.

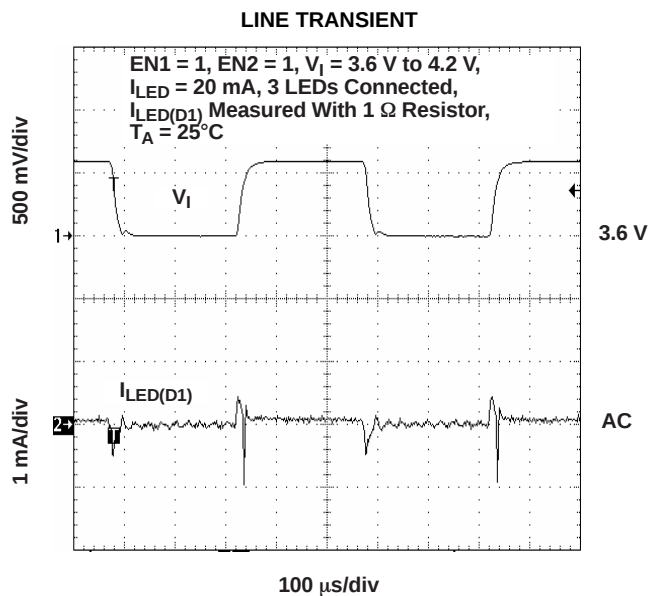


Figure 8.

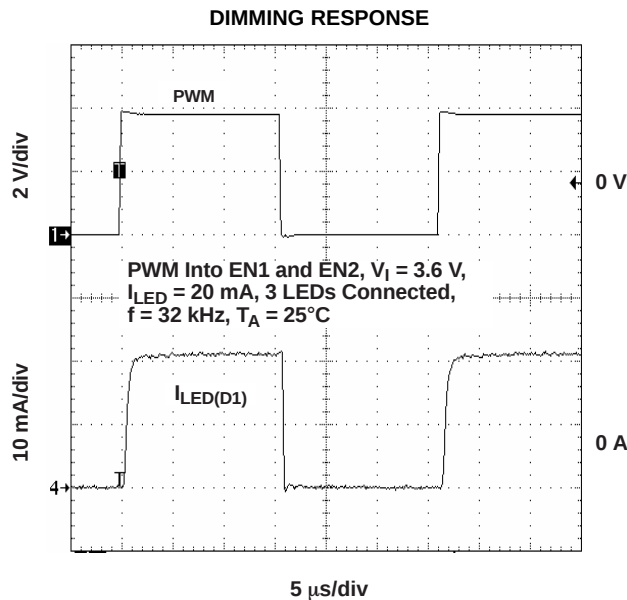


Figure 9.

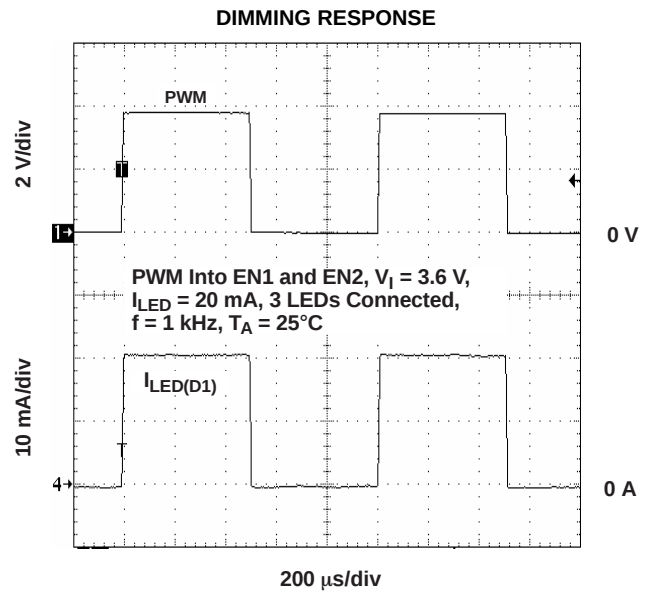


Figure 10.

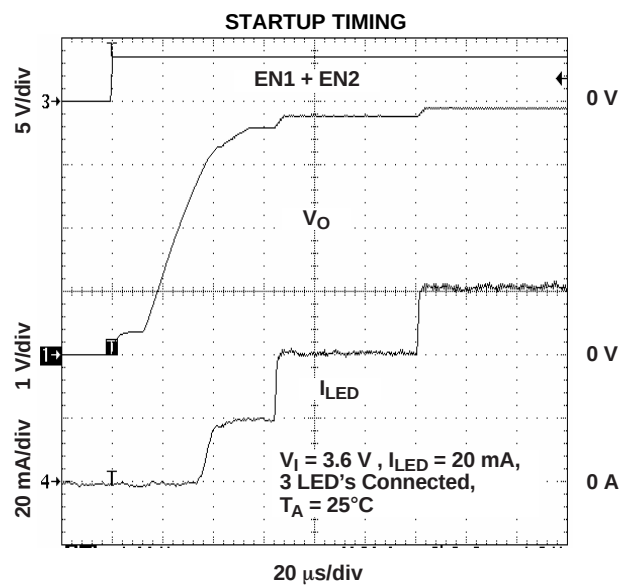


Figure 11.

## DETAILED DESCRIPTION

### OPERATION

The TPS60231 uses a fractional conversion charge pump to generate a supply voltage for the integrated current sinks. These current sinks are used to ensure a constant current for each LED. Depending on the input voltage and programmed LED current, the charge pump either operates in the 1x mode or in the 1.5x mode. By switching automatically between these two modes, the circuit optimizes power conversion efficiency as well as extends operating time by allowing the discharge of the battery completely.

The charge pump can generate 75 mA of output current, so each of the 3 LED outputs can be powered with up to 25 mA of current. The maximum LED current is set by a resistor connected to the ISET pin. This resistor programs a reference current, which is current mirrored to set the LED current.

Applying a PWM signal to the EN1 pin and/or the EN2 pin controls the LED brightness. See a detailed description in the section Analog Dimming Using ISET Pin.

## LED CURRENT ADJUSTMENT (ISET)

A resistor programs a reference current, which is current mirrored to set the LED current. The voltage at the ISET pin depends on the status of EN1 and EN2. The current in each LED is typically 260 times the current through the resistor at ISET.

$$R_{ISET} = \frac{V_{ISET}}{I_{LED}} \times K$$

$V_{ISET}$  — Voltage from ISET pin (0.2 V, 0.4 V or 0.6 V) to GND, see [Table 1](#)

$I_{LED}$  — Current per LED from Dx pin to GND

K — Dx to  $I_{SET}$  current ratio (typically 260)

The LED current varies linearly from 0 mA to  $I_{LED(max)}$  mA by applying a PMW signal with 0% to 100% duty cycle. The LED brightness can however also be controlled by an analog control signal that is fed into the ISET pin.

## SOFT START

The TPS60231 has an internal soft start circuit to limit the inrush current during startup. This prevents possible voltage drops of the input voltage if a high impedance power source is connected to the input of the TPS60231. When the device starts up with an output voltage that is below the input voltage, the output capacitor is charged directly from the input with a current source. The output current increases linearly until the output reaches within 300 mV of the input voltage. When the programmed output current can be reached with the 1x mode, the TPS60231 terminates the soft start and begins normal operation. When the desired output current cannot be reached, the charge pump begins operation in 1.5x mode and pumps the output voltage up to the needed level to reach the programmed output current.

## ENABLE (EN1, EN2)

The enable pins EN1 and EN2 are used to enable the device or set it into shutdown. The TPS60231 is enabled if one of the enable pins is pulled higher than the enable trip point of 1.3 V. The device starts up by going through the soft start routine as described in the section Soft Start. Pulling both pins to GND, after a delay, programs the device to shutdown. In shutdown, the charge pump, current sources, voltage reference, oscillator, and all other functions are turned off and the supply current is reduced to 0.1  $\mu$ A.

EN1 and EN2 can also be used for dimming. The logic levels at EN1 and EN2 set the minimum voltage at the current mirrors and the voltage at the ISET pin to GND. This sets the current at the LEDs to be either the full current or a fraction of the full current. See [Table 1](#) for further details. The maximum current through the LEDs is set by a resistor connected between ISET and GND.

EN1 and EN2 can also be used for PWM dimming. The PWM signal can either be applied to EN1 or EN2, or both inputs can be tied together and the PWM signal can be applied to both pins. Depending on the configuration, the current during PWM dimming is switched between 0 mA and its maximum (EN1 and EN2 connected to the PWM signal) or between 0 mA and 1/3 of the full LED current if EN2 = 0 and EN1 is toggled. When EN1 = 0 and EN2 is toggled, the output current can be changed between 0 mA and 2/3 of the full range.

**Table 1. Enable Levels**

| ENABLE LEVEL |     | MODE                        | LED CURRENT |
|--------------|-----|-----------------------------|-------------|
| EN2          | EN1 |                             |             |
| 0            | 0   | SHUTDOWN                    | 0           |
| 0            | 1   | $V_{ISET} = 200 \text{ mV}$ | 1/3         |
| 1            | 0   | $V_{ISET} = 400 \text{ mV}$ | 2/3         |
| 1            | 1   | $V_{ISET} = 600 \text{ mV}$ | Full        |

## UNDERVOLTAGE LOCKOUT

The undervoltage lockout circuit shuts down the device when the voltage at VIN drops below a typical threshold of 2.15 V. This prevents damage to the device. The UVLO circuit allows the device to start up again after the voltage on the VIN pin has increased by about 50 mV above the UVLO lockout threshold.

## SHORT CIRCUIT AND OVERTEMPERATURE PROTECTION

The current at the VOUT pin is limited typically to 250 mA. When the junction temperature exceeds 160°C, the device shuts down to protect the device from damage. After the temperature decreases to about 140°C, the device starts up again if it is enabled.

## OVERVOLTAGE PROTECTION AT VOUT

The device uses the voltage at D1 to regulate voltage at VOUT. In case D1 is not connected, an overvoltage protection circuit ensures that the output voltage at VOUT does not exceed its limits. The connection of the LEDs must be started using D1 first. For all other LEDs there is no restriction in the sequence. For example, if there are only 2 LEDs used, the first LED is connected to D1 and the other LED can be connected to any other of the D2 to D3 pins.

## THEORY OF OPERATION/DESIGN PROCEDURE

### Capacitor Selection

Ceramic capacitors such as X5R or X7R are recommended to be used with the TPS60231. For the two flying capacitors C1 and C2, it is important to use low ESR capacitors to avoid unnecessary efficiency losses. Low ESR capacitors on VOUT reduce the ripple voltage on the supply of the current sources. [Table 2](#) lists capacitor types that have been tested with the TPS60231.

**Table 2. Capacitors**

| PART           | VALUE        | VOLTAGE | MANUFACTURER | SIZE | WEBSITE               |
|----------------|--------------|---------|--------------|------|-----------------------|
| C1608X5R1A105M | 1 $\mu$ F    | 10 V    | TDK          | 0603 | www.component.tdk.com |
| C1608X5R1A474M | 0.47 $\mu$ F | 10 V    |              | 0603 |                       |
| C2012X7R1C105M | 1 $\mu$ F    | 16 V    |              | 0805 |                       |
| LMK107BJ105MA  | 1 $\mu$ F    | 10 V    | Taiyo Yuden  | 0603 | www.t-yuden.com       |
| LMK107BJ474MA  | 0.47 $\mu$ F | 10 V    |              | 0603 |                       |
| LMK212BJ105MG  | 1 $\mu$ F    | 10 V    |              | 0805 |                       |

### Power Efficiency

The power conversion efficiency of the TPS60231 can be calculated by adding up the products of each LED current and voltage and dividing it by the product of the input voltage and current. With a fully charged battery where the input voltage is typically above the LED forward voltage, the charge pump operates in the 1x mode and efficiency is very high. As the battery discharges, there is a point where the current sources no longer have enough voltage overhead to maintain a constant current regulation. At that point, the charge pump switches into the 1.5x mode. The conversion efficiency is lowest at the crossover. As the battery discharges further, the efficiency again increases until at about 3.1 V where it reaches a second maximum. Below 3.1 V input voltage, the maximum current per LED is less than 25 mA.

### Power Dissipation

The maximum power dissipation inside the TPS60231 can be calculated based on the following equation:

$$P_{D \max} = [(1.5 \times V_I) - V_O + 0.4 \text{ V}] \times I_O$$

The maximum power dissipation occurs when the input voltage is just low enough to operate in 1.5x mode, with a forward voltage of the white LED at maximum. This is typically for  $V_I = 4.2 \text{ V}$  and a forward voltage of 3.6 V.

This needs to be lower than the maximum allowed power dissipation of the package, which can be calculated using the following equation:

$$P_{D \text{ max, package}} = \frac{T_{J\text{max}} - T_A}{R_{\theta ja}}$$

For example, the worst case power dissipation occurs at the input voltage level where the charge pump switches from the 1x mode to the 1.5x mode. At this operating point, the supply voltage to the current sources is at its maximum and the current sources must drop the most voltage in order to maintain a regulated output current. The worst case power dissipation occurs when all 3 LED outputs are fully loaded with 25 mA of LED current.

- With:  $V_I = 4.2 \text{ V}$ ,  $V_f = 3.6 \text{ V}$ ,  $I_O = 75 \text{ mA}$  (1.5x mode)
- $P_{D \text{ max}} = 0.23 \text{ W}$

## APPLICATION INFORMATION

### TYPICAL APPLICATION OF A SMART PHONE DISPLAY WITH RESISTORS CONNECTED IN PARALLEL

If more than 25 mA of output current is needed, then the input pins to the current sinks can be connected in parallel as shown in the following application figure. This method can also be used to connect a LC display with only two connections for the white LEDs.

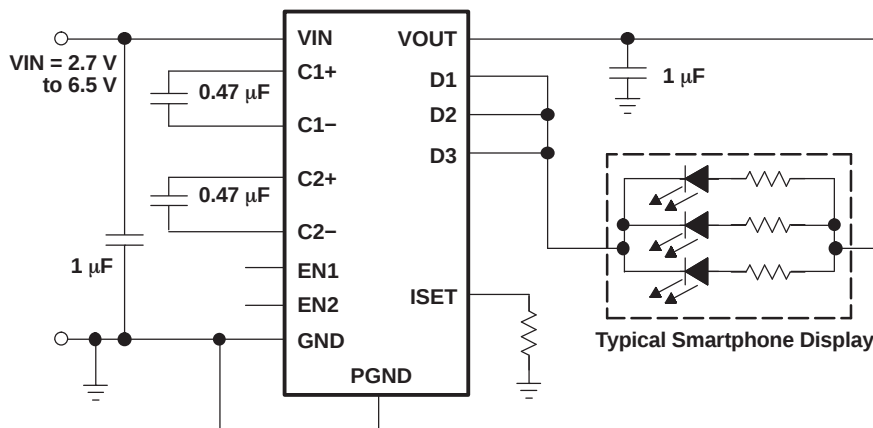


Figure 12. Typical Application With Resistors in Parallel

### ANALOG DIMMING USING ISET PIN

The ISET pin can be used to connect an analog dc signal in the range of 0 mV to 600 mV ( $EN1 = EN2 = 1$ ) for analog dimming of the white LEDs. For an input voltage of 0 V at ISET, the current is at its maximum, whereas at 600 mV, the LED current is zero. The maximum current is:

- For  $EN2 = EN1 = 1$ :  $I_{LED} = V_{set}/R_{set} \times K = 0.6V/6k\Omega \times 260 = 26 \text{ mA per LED}$
- For  $EN2 = 1$ ,  $EN0 = 1$ :  $I_{LED} = V_{set}/R_{set} \times K = 0.4V/6k\Omega \times 260 = 17 \text{ mA per LED}$
- For  $EN2 = 0$ ,  $EN1 = 1$ :  $I_{LED} = V_{set}/R_{set} \times K = 0.2V/6k\Omega \times 260 = 8.6 \text{ mA per LED}$
- With  $EN2$ ,  $EN1$  set to 10 or 01, a voltage of 400 mV or 200 mV is required to set the LED current to zero.

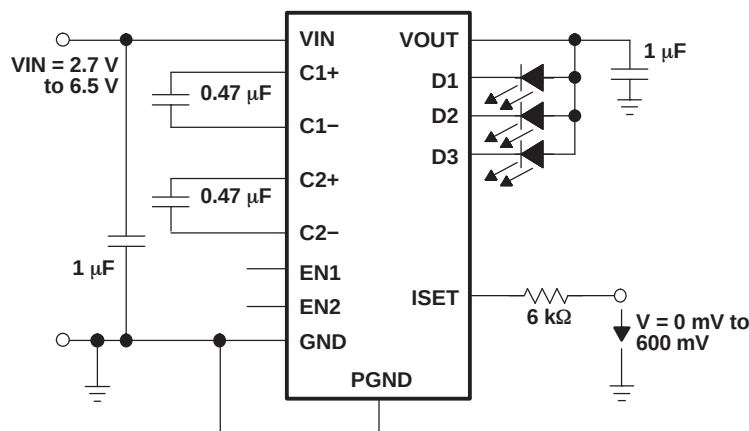


Figure 13. Analog Dimming Connections Using ISET Pin

### TYPICAL APPLICATION USING 2 WHITE LEDs AND 6 GREEN LEDs FOR LCD BACKLIGHT AND KEYBOARD LIGHTING

The TPS60231 can be used to power any kind of LED. It is also possible to mix white LEDs with color LEDs which have a lower forward voltage. The LED with the highest forward voltage (typically the white LED) has to be connected to D1, because the output voltage of the charge pump is regulated in such a way to keep the voltage drop from D1 to GND at 400mV (with EN1 = EN2 = 1). Therefore the output voltage of the charge pump is regulated to:

$$V_{OUT} = V_{D1} + V_{FLEDD1}$$

$V_{OUT}$  — Output voltage at VOUT

$V_{D1}$  — Voltage from D1 to GND ( $V_{source}$  at D1 pin, see electrical characteristics)

$V_{FLEDD1}$  — Forward voltage of the LED connected to D1

Resistor  $R_g$  is used to provide current sharing between the 6 green LEDs. The upper value is calculated using:

$$R_g = \frac{V_{FLEDD1} - V_{Fg}}{I_g}$$

$V_{Fg}$  — Forward voltage of a green LED

$I_g$  — Current per green LED

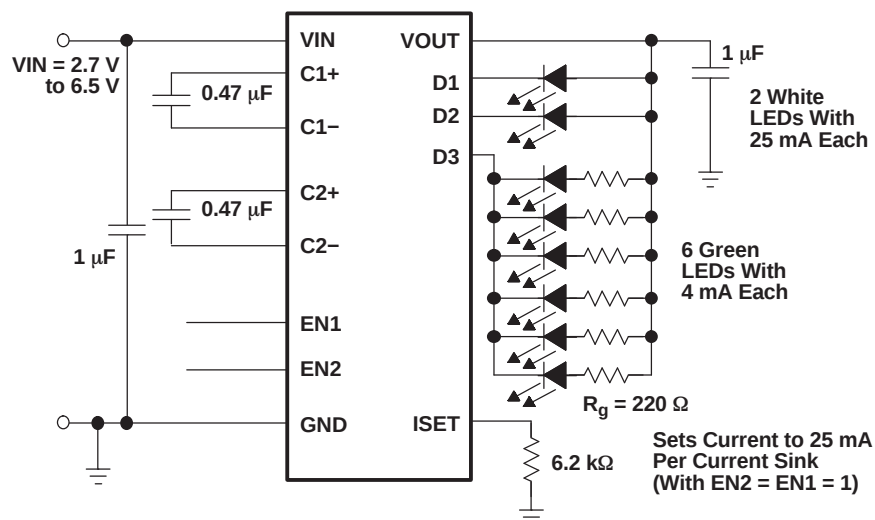


Figure 14. LED Connections for LCD Backlight and Keyboard Lighting

## PROPOSED LAND PATTERN FOR PCB PRODUCTION

See the application note [SLUA271](#) for the proposed land pattern of the QFN package.

## REVISION HISTORY

### Changes from Original (October 2004) to Revision A

Page

- Added a Test Condition to the Input voltage range of the ELECTRICAL CHARACTERISTICS -  $I_O = 0$  mA to 45 mA,  $V_{LED} \leq 2.1$  V,  $T = ^\circ\text{C}$  to  $85^\circ\text{C}$  ..... 3

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS60231RGTR     | ACTIVE        | VQFN         | RGT                | 16   | 3000           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | BKH                     | <a href="#">Samples</a> |
| TPS60231RGTRG4   | ACTIVE        | VQFN         | RGT                | 16   | 3000           | TBD             | Call TI                              | Call TI              | -40 to 85    |                         | <a href="#">Samples</a> |
| TPS60231RGTT     | ACTIVE        | VQFN         | RGT                | 16   | 250            | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | BKH                     | <a href="#">Samples</a> |
| TPS60231RGTTG4   | ACTIVE        | VQFN         | RGT                | 16   | 250            | TBD             | Call TI                              | Call TI              | -40 to 85    |                         | <a href="#">Samples</a> |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS60231RGTR | VQFN         | RGT             | 16   | 3000 | 330.0              | 12.4               | 3.3     | 3.3     | 1.1     | 8.0     | 12.0   | Q2            |
| TPS60231RGTT | VQFN         | RGT             | 16   | 250  | 180.0              | 12.4               | 3.3     | 3.3     | 1.1     | 8.0     | 12.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

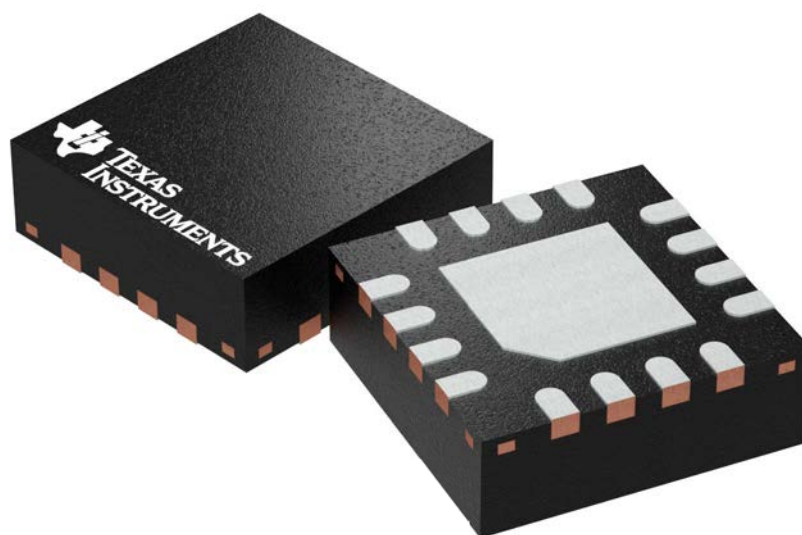
| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS60231RGTR | VQFN         | RGT             | 16   | 3000 | 367.0       | 367.0      | 35.0        |
| TPS60231RGTT | VQFN         | RGT             | 16   | 250  | 210.0       | 185.0      | 35.0        |

**RGT 16**

**GENERIC PACKAGE VIEW**

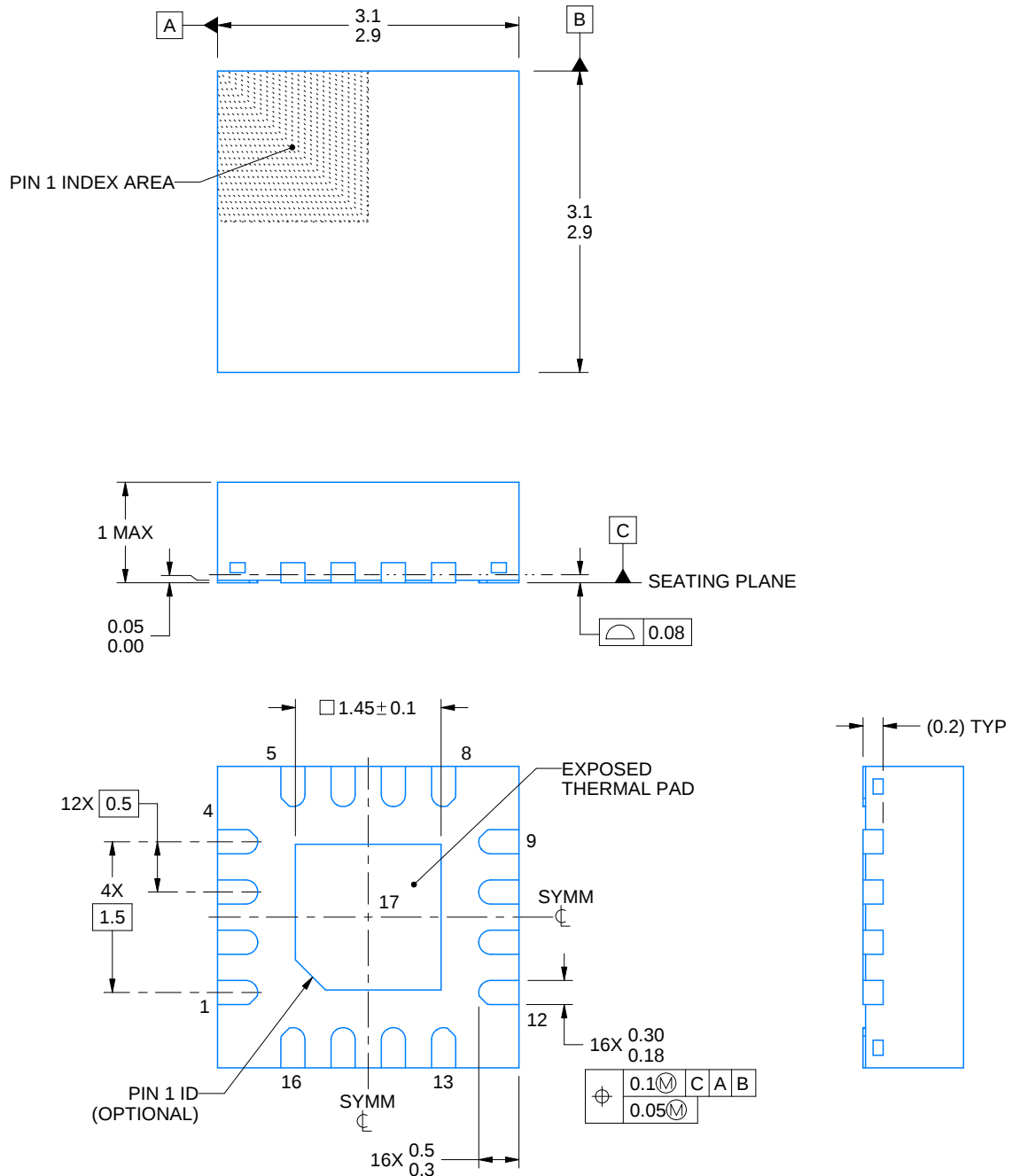
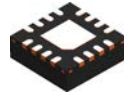
**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

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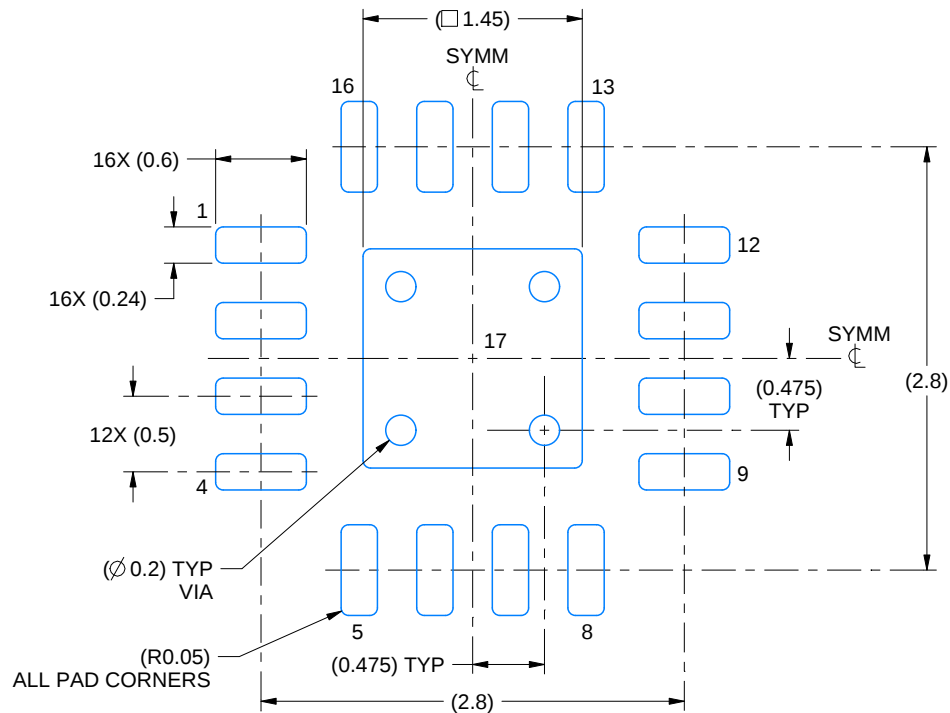
## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.
4. Reference JEDEC registration MO-220

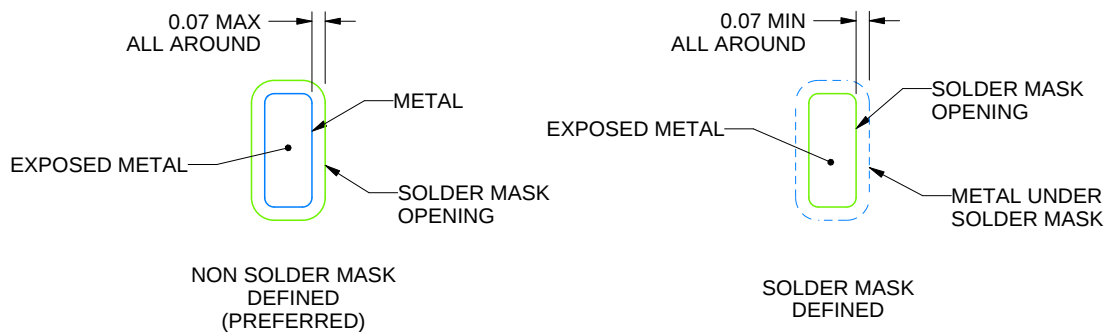
**RGT0016A**

**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:20X



## SOLDER MASK DETAILS

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NOTES: (continued)

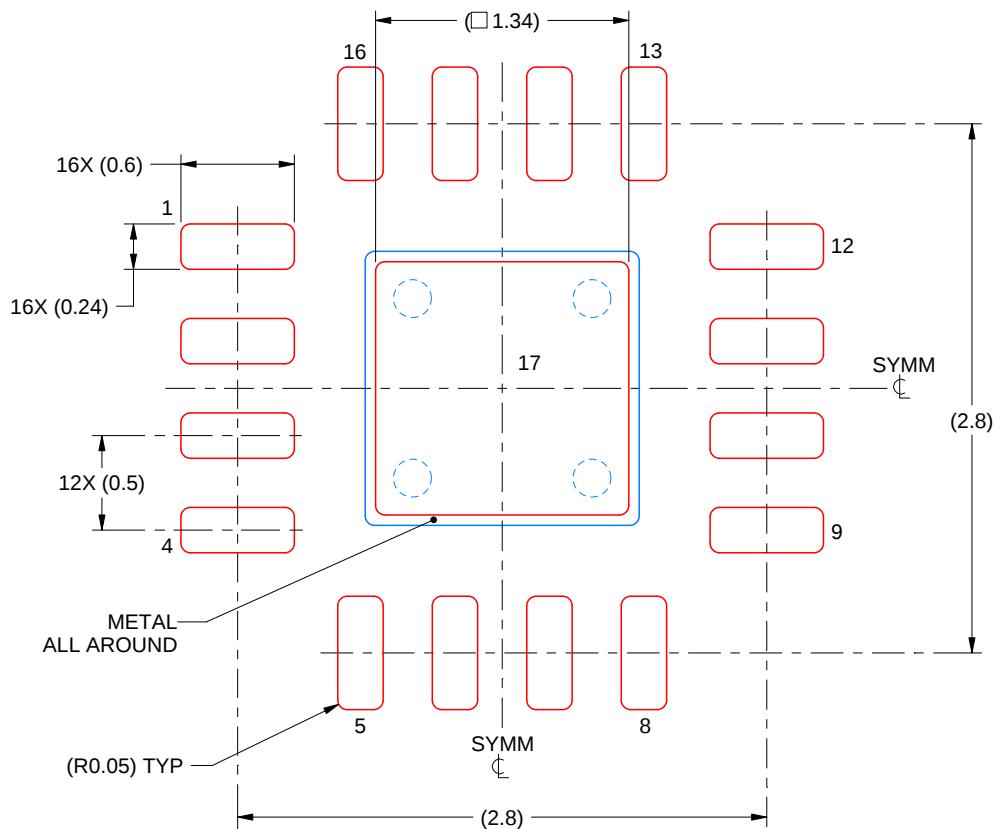
5. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
6. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RGT0016A

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
 BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 17:  
 86% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
 SCALE:25X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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